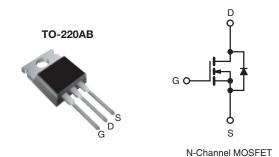


## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	600				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 2.2				
Q <sub>g</sub> (Max.) (nC)	31				
Q <sub>gs</sub> (nC)	4.6				
Q <sub>gd</sub> (nC)	17				
Configuration	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC30PbF			
	SiHFBC30-E3			
SnPb	IRFBC30			
OIII D	SiHFBC30			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	600	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V at 10 V	T <sub>C</sub> = 25 °C		3.6		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.3	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	14		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	290	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	3.6	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	74	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	00	
Soldering Recommendations (Peak Temperature) for 10 s			_	300 <sup>d</sup>	°C	
Manualina Taurus	0.00.54	0.00 140		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 41 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.6 A (see fig. 12).
- c.  $I_{SD} \le 3.6$  A,  $dI/dt \le 60$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7			

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	600	-	-	٧
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	:o 25 °C, I <sub>D</sub> = 1 mA	-	0.62	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
Zava Cata Valtaga Dyain Current	1	V <sub>DS</sub> = 6	00 V, V <sub>GS</sub> = 0 V	-	-	100	μА
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	
Drain Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.2 A <sup>b</sup>	-	-	2.2	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10	00 V, I <sub>D</sub> = 2.2 A <sup>b</sup>	2.5	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,	-	660	-	
Output Capacitance	C <sub>oss</sub>	V	os = 25 V,	-	86	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0	MHz, see fig. 5	-	19	-	
Total Gate Charge	Qg			-	-	31	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 3.6 \text{ A}, V_{DS} = 360 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		-	-	4.6	nC
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 and 16	-	-	17	1 !
Turn-On Delay Time	t <sub>d(on)</sub>			-	11	-	
Rise Time	t <sub>r</sub>	V22 - 30	00 V, I <sub>D</sub> = 3.6 A ,	-	13	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{g} = 12 \Omega$ , $R_{D} = 82 \Omega$ , see fig. $10^{b}$		-	35	-	ns
Fall Time	t <sub>f</sub>			-	14	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	ווח
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		i	-	3.6	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			ı	-	14	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3.6 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T OF °C !	0 C A 41/4+ 400 A 4:h	-	370	810	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = 3.6 \text{A}, dI/dt = 100 \text{A}/\mu\text{s}^b$		-	2.0	4.2	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	n-on is dominated by L <sub>S</sub> and L <sub>D</sub> )			L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

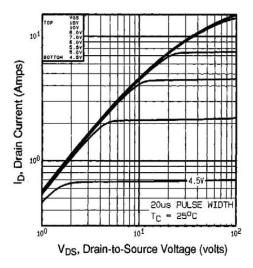


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

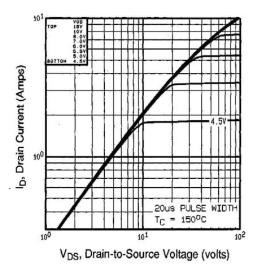
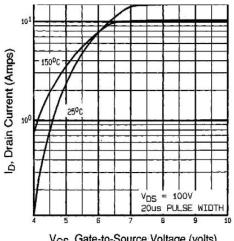


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C



VGS, Gate-to-Source Voltage (volts)

Fig. 3 - Typical Transfer Characteristics

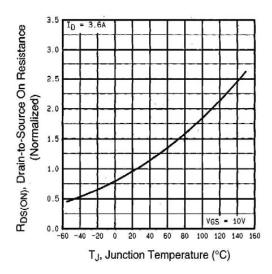


Fig. 4 - Normalized On-Resistance vs. Temperature



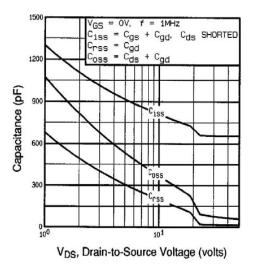


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

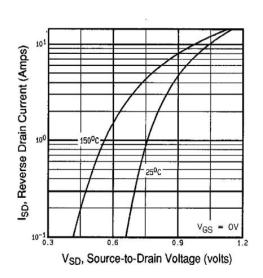


Fig. 7 - Typical Source-Drain Diode Forward Voltage

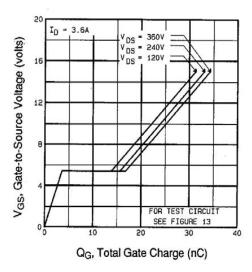


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

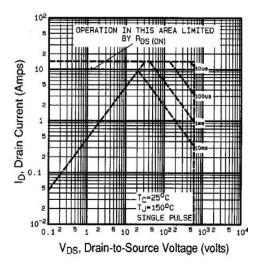


Fig. 8 - Maximum Safe Operating Area





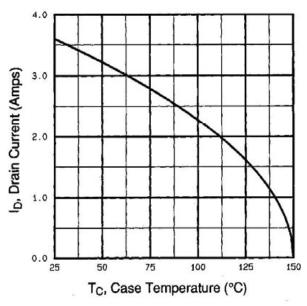


Fig. 9 - Maximum Drain Current vs. Case Temperature

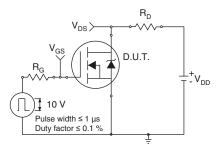


Fig. 10a - Switching Time Test Circuit

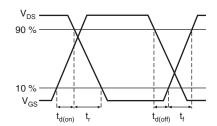


Fig. 10b - Switching Time Waveforms

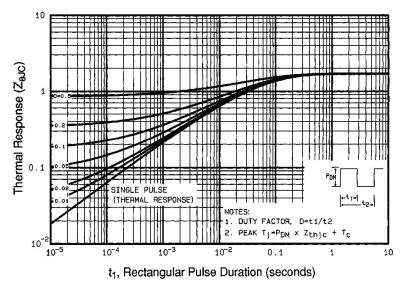
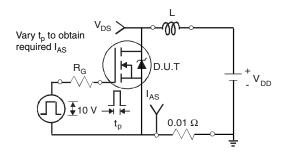
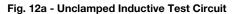


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case







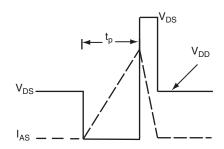


Fig. 12b - Unclamped Inductive Waveforms

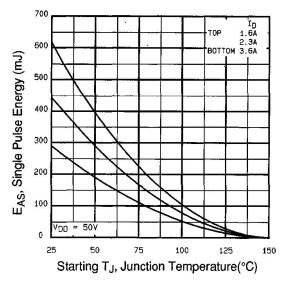


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

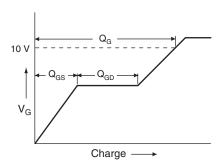


Fig. 13a - Basic Gate Charge Waveform

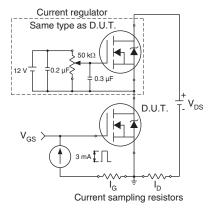
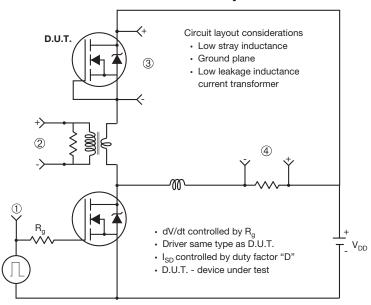


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



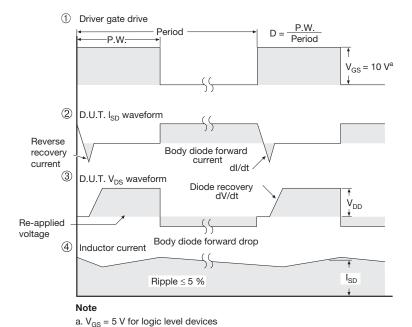
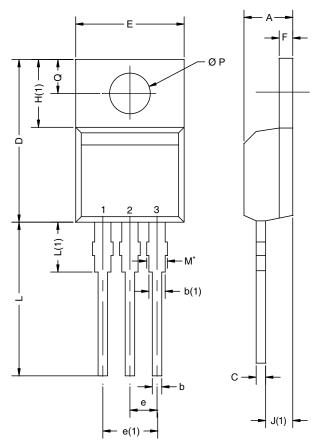


Fig. 14 - For N-Channel

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## **TO-220AB**



		D2

	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471					

#### Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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Revision: 02-Oct-12 Document Number: 91000

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TK16J60W,S1VQ(O 2SK2614(TE16L1,Q) DMN1017UCP3-7 DMN1053UCP4-7 SQJ469EP-T1-GE3 NTE2384 DMC2700UDMQ-7
DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
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